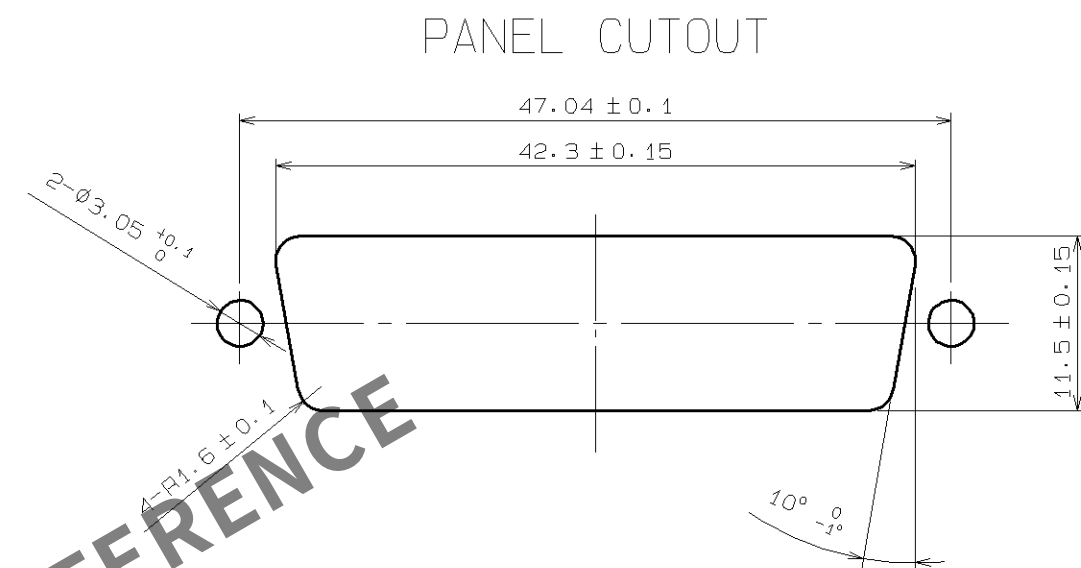
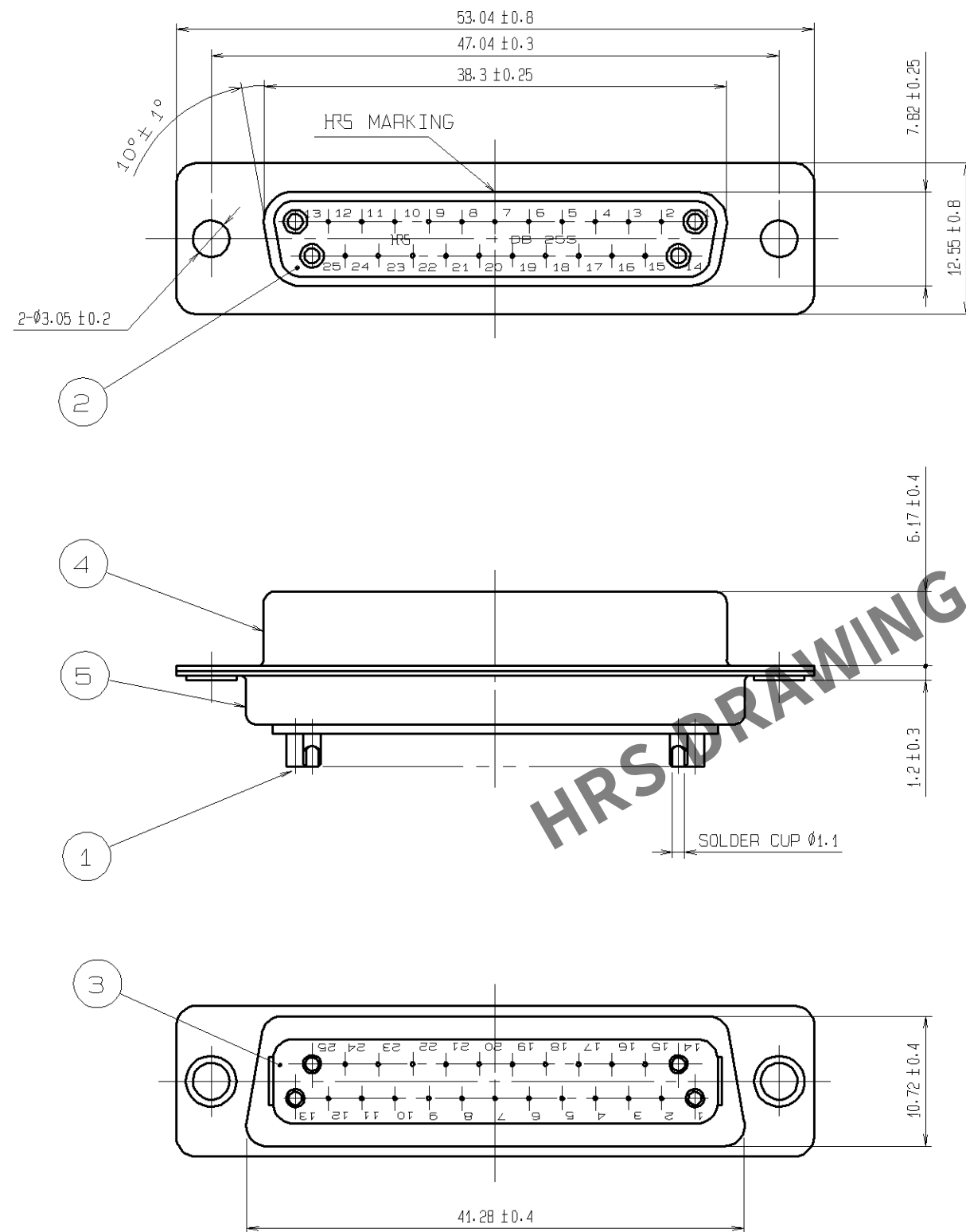


NOTE 1. SOLDERING SHALL BE DOWN WITH SOLDERING BIT OF 40W MAX WITHIN 4s.
2. CONTACT AREA: GOLD PLATING $0.2\mu\text{m}$ MIN
TERMINAL AREA: GOLD PLATING $0.03\mu\text{m}$ MIN
UNDERPLATING: NICKEL PLATING $1\mu\text{m}$ MIN

3	PBT	UL94V-0 BLACK					
2	PBT	UL94V-0 BLACK	5	STEEL	NICKEL PLATING $2\mu\text{m}$		
1	PHOSPHOR BRONZE	2	4	STEEL	NICKEL PLATING $2\mu\text{m}$		
NO.	MATERIAL	FINISH. REMARKS	NO.	MATERIAL	FINISH. REMARKS		
UNITS mm		SCALE 2 : 1	COUNT 1	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED
HIROSE ELECTRIC CO., LTD.		APPROVED : H0.MIWA	06.07.26	DRAWING NO.		EDC3-009500-03	
		CHECKED : H0.MIWA	06.07.26	PART NO.		HDBB-25S(05)	
		DESIGNED : YH.ENAMI	06.07.26	CODE NO.		CL211-0216-0-05	
		DRAWN : YH.ENAMI	06.07.26			1/1	